# **LN58**

### GaAs Infrared Light Emitting Diode

For optical control systems

#### ■ Features

- High-power output, high-efficiency:  $P_O = 3.5 \text{ mW (typ.)}$
- Emitted light spectrum suited for silicon photodetectors
- Infrared light emission close to monochromatic light:  $\lambda_P = 950 \text{ nm}$  (typ.)
- Small size, thin side-view type package

#### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Power dissipation	$P_{\mathrm{D}}$	75	mW	
Forward current	$I_{F}$	50	mA	
Pulse forward current *	$I_{FP}$	1	A	
Reverse voltage	V <sub>R</sub>	3	V	
Operating ambient temperature	T <sub>opr</sub>	-25 to +85	°C	
Storage temperature	T <sub>stg</sub>	-30 to +100	°C	

Note) \*: f = 100 Hz, Duty cycle = 0.1%

### $\blacksquare$ Electro-Optical Characteristics $\rm T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Radiant power *	Po	$I_F = 50 \text{ mA}$	1.8	3.5		mW
Reverse current	$I_R$	$V_R = 3 V$			10	μΑ
Forward voltage	$V_{\mathrm{F}}$	$I_F = 50 \text{ mA}$			1.5	V
Terminal capacitance	Ct	$V_R = 0 \text{ V}, f = 1 \text{ MHz}$		35		pF
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 50 \text{ mA}$		950		nm
Spectral half band width	Δλ	$I_F = 50 \text{ mA}$		50		nm
Half-power angle	θ	The angle when the radiant power is halved.		35		0

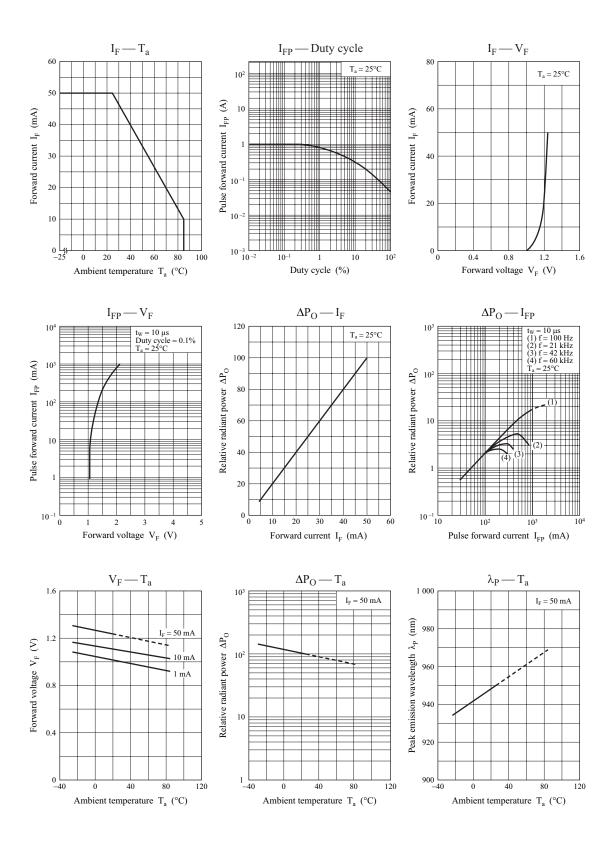
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. Cutoff frequency: 1 MHz

$$f_C$$
:  $10 \times log \frac{P_O \text{ at } f = f_C}{P_O \text{ at } f = 50 \text{ kHz}} = -3$ 

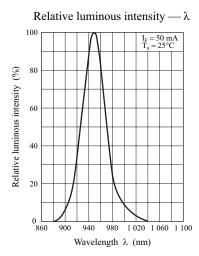
3. \*: A light detection element uses a silicon diode have proofread a load with a standard device.

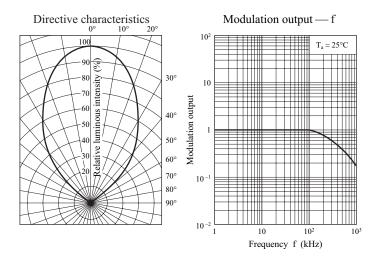
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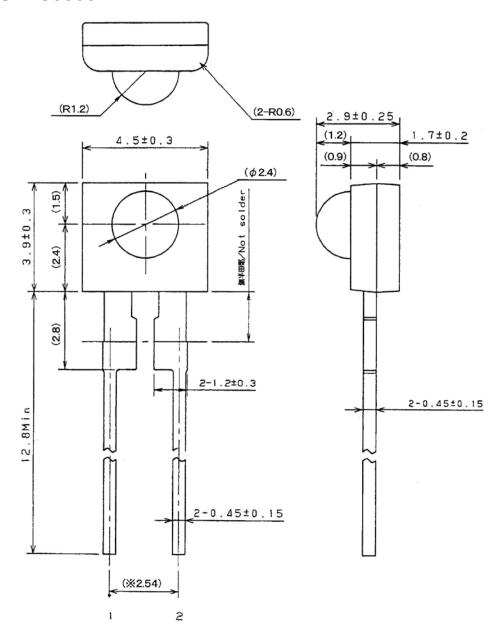




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#### ■ Package (Unit: mm)

## LETLSN2S0003



- Pin name
  - 1: Cathode
  - 2: Anode

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